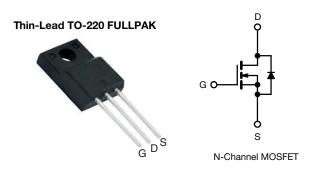
SiHA21N65EF

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Vishay Siliconix

E Series Power MOSFET with Fast Body Diode



PRODUCT SUMMARY						
V _{DS} (V) at T _J max.	700					
R _{DS(on)} max. (Ω) at 25 °C	$V_{GS} = 10 V$	0.18				
Q _g max. (nC)	106					
Q _{gs} (nC)	14					
Q _{gd} (nC)	33					
Configuration	Single					

FEATURES

- Fast body diode MOSFET using E series technology
- Reduced t_{rr}, Q_{rr}, and I_{RRM}
- Low figure-of-merit (FOM) Ron x Qg
- Low input capacitance (Ciss)
- Low switching losses due to reduced Q_{rr}
- Ultra low gate charge (Qg)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Telecommunications
- Server and telecom power supplies
- Lighting
- High-intensity discharge (HID) - Fluorescent ballast lighting
- Consumer and computing
- ATX power supplies
- Industrial
- Welding
 - Battery chargers
- Renewable energy
 Solar (PV inverters)
- Solar (PV Inverters)
 Switch mode power supplies (SMPS)
- Applications using the following topologies
 - LCC
 - Phase shifted bridge (ZVS)
 - 3-level inverter
 - AC/DC bridge
- ORDERING INFORMATION

 Package
 Thin-Lead TO-220 FULLPAK

 Lead (Pb)-free
 SiHA21N65EF-E3

 Lead (Pb)-free and halogen-free
 SiHA21N65EF-GE3

ABSOLUTE MAXIMUM RATINGS (T C	= 25 °C, unless otherwi	se noted)		
PARAMETER	SYMBOL	LIMIT	UNIT	
Drain-source voltage	V _{DS}	650	v	
Gate-source voltage	V _{GS}	± 30	V V	
Continuous drain current (T _J = 150 °C) ^e	$V_{GS} \text{ at } 10 \text{ V} \qquad \frac{T_{C} = 25 \text{ °C}}{T_{C} = 100 \text{ °C}}$	1-	21	
	$T_{\rm C} = 100 ^{\circ}{\rm C}$	I _D	13	А
Pulsed drain current ^a	I _{DM}	53		
Linear derating factor		0.28	W/°C	
Single pulse avalanche energy ^b	E _{AS}	367	mJ	
Maximum power dissipation	PD	35	W	
Operating junction and storage temperature range	T _J , T _{stg}	-55 to +150	°C	
Drain-source voltage slope	T _J = 125 °C	d\//dt	37	1//22
Reverse diode dV/dt ^d	dV/dt	31	V/ns	
Soldering recommendations (peak temperature) ^c	for 10 s		300	°C
Mounting torque	M3 screw		0.6	Nm

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature

b. V_{DD} = 50 V, starting T_J = 25 °C, L = 28.2 mH, R_g = 25 Ω , I_{AS} = 5.1 A

c. 1.6 mm from case

d. $I_{SD} \leq I_D, \, dI/dt$ = 100 A/µs, starting T_J = 25 $^\circ C$

e. Limited by maximum junction temperature

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(Pb) RoHS

COMPLIANT

HALOGEN



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PARAMETER	SYMBOL	TYP.		MAX.		UNIT		
Maximum junction-to-ambient	R _{thJA}	-		65				
Maximum junction-to-case (drain)	R _{thJC}	-	- 3.6			°C/W		
SPECIFICATIONS ($T_J = 25 \degree C$,	unless otherwi	ise noted)						
PARAMETER	SYMBOL	1)NS	MIN.	TYP.	MAX.	UNI
Static	OTHEOL	120					MAX.	
Drain-source breakdown voltage	V _{DS}	Vac	= 0 V, I _D = 2	50	650	_	-	v
V _{DS} temperature coefficient	$\Delta V_{DS}/T_J$		e to 25 °C, I		-	0.67	_	V/°(
Gate-source threshold voltage (N)	V _{GS(th)}	-	$= V_{GS}, I_D = 2$		2	-	4	V
Gale-source inteshold voltage (N)	VGS(th)		$V_{GS} = \pm 20$ V _{GS} = ± 20 V		-	_	4 ± 100	nA
Gate-source leakage	I _{GSS}		$\frac{V_{GS} = \pm 20}{V_{GS} = \pm 30}$		_	_	± 100	
			$V_{GS} = \pm 30$ V = 520 V, V _{GS}		_	_	1	μA μA
Zero gate voltage drain current	I _{DSS}				-	-	500	
Drain-source on-state resistance	R _{DS(on)}	$V_{DS} = 520 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 125 ^{\circ}\text{C}$ $V_{GS} = 10 \text{ V}$ $I_{D} = 11 \text{ A}$		-	- 0.15	0.18	Ω	
Forward transconductance	g _{fs}		= 30 V, I _D =		-	7.0	-	S
Dynamic	915	•DS	= 00 V, ID =	117		1.0		
Input capacitance	C _{iss}	· · · · ·			-	2322	-	pF
Output capacitance	C _{oss}	$V_{GS} = 0 V,$ $V_{DS} = 100 V,$ f = 1 MHz		_	105	-		
Reverse transfer capacitance	C _{rss}			-	4	-		
Effective output capacitance, energy		- V _{DS} = 0 V to 520 V, V _{GS} = 0 V						
related ^a	C _{o(er)}			-	84	-		
Effective output capacitance, time related ^b	C _{o(tr)}			-	293	-		
Total gate charge	Qg			-	71	106		
Gate-source charge	Q _{gs}	$V_{GS} = 10 V$	V _{GS} = 10 V I _D = 11 A, V _{DS} = 520 V		-	14	-	nC
Gate-drain charge	Q _{gd}				-	33	-	
Turn-on delay time	t _{d(on)}	V_{DD} = 520 V, I _D = 11 A, V _{GS} = 10 V, R _g = 9.1 Ω		-	22	44		
Rise time	t _r			-	34	68	- ns	
Turn-off delay time	t _{d(off)}			-	68	102		
Fall time	t _f			-	42	84		
Gate input resistance	R _g	f = 1 MHz, open drain		-	0.78	-	Ω	
Drain-Source Body Diode Characterist	ics							
Continuous source-drain diode current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	21	- A	
Pulsed diode forward current	I _{SM}			-	-	53		
Diode forward voltage	V _{SD}	$T_{\rm J}$ = 25 °C, $I_{\rm S}$ = 11 A, $V_{\rm GS}$ = 0 V		-	0.9	1.2	V	
Reverse recovery time	t _{rr}	T _J = 25 °C, I _F = I _S = 11 A, dl/dt = 100 A/μs, V _R = 25 V		-	160	-	ns	
Reverse recovery charge	Q _{rr}			-	1.2	-	μΟ	
Reverse recovery current	I _{RRM}			-	14	-	A	

Notes

a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS}

b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS}



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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

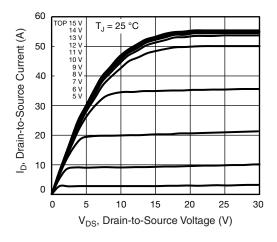


Fig. 1 - Typical Output Characteristics

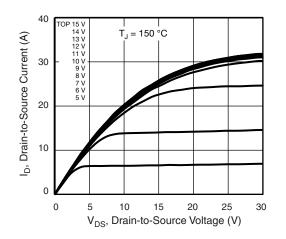
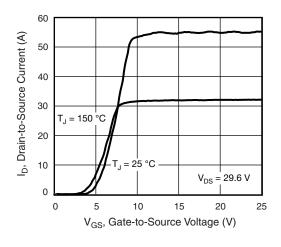


Fig. 2 - Typical Output Characteristics





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3 R_{DS(on)}, Drain-to-Source On Resistance (Normalized) 2.5 2 1.5 10 V 1 V_{GS} 0.5 0 - 60 - 40 -20 0 20 40 60 80 100 120 140 160 T_J, Junction Temperature (°C)

Fig. 4 - Normalized On-Resistance vs. Temperature

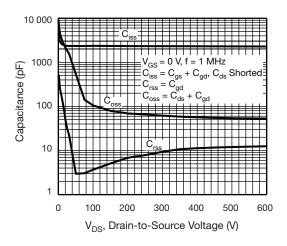


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

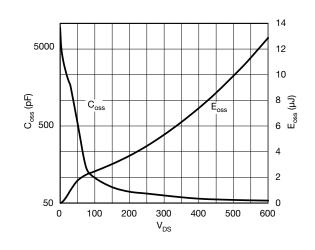


Fig. 6 - C_{oss} and E_{oss} vs. V_{DS}

3 For technical questions, contact: <u>hvm@vishay.com</u>

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24 V_{DS} = 520 V V_{GS}, Gate-to-Source Voltage (V) V_{DS} = 325 V 20 V_{DS} = 130 V = 16 12 8 4 0 0 30 60 90 120 150 Q_q, Total Gate Charge (nC)

Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

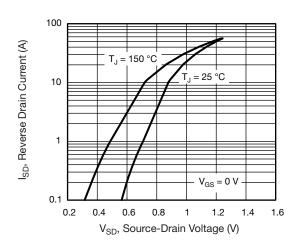


Fig. 8 - Typical Source-Drain Diode Forward Voltage

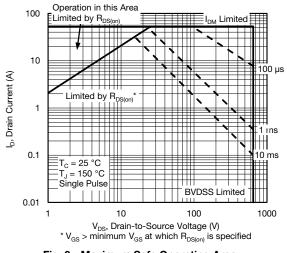


Fig. 9 - Maximum Safe Operating Area

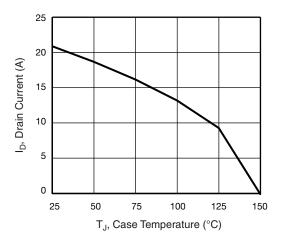


Fig. 10 - Maximum Drain Current vs. Case Temperature

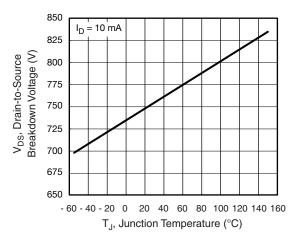


Fig. 11 - Temperature vs. Drain-to-Source Voltage

4

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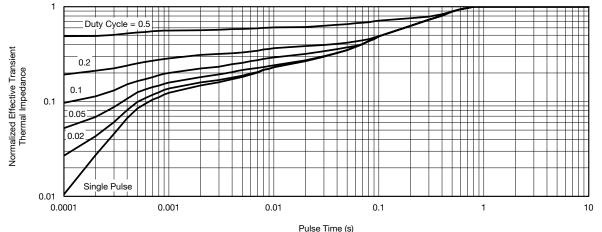
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Puise Time (s)



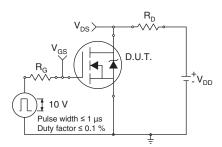


Fig. 13 - Switching Time Test Circuit

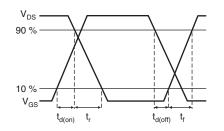


Fig. 14 - Switching Time Waveforms

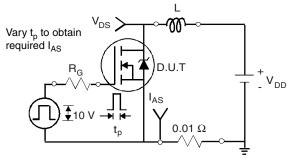


Fig. 15 - Unclamped Inductive Test Circuit

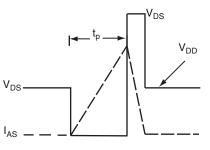


Fig. 16 - Unclamped Inductive Waveforms

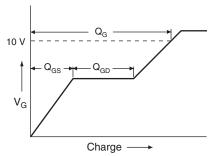


Fig. 17 - Basic Gate Charge Waveform

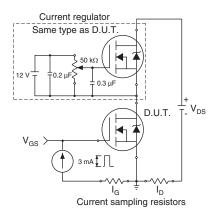


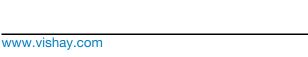
Fig. 18 - Gate Charge Test Circuit

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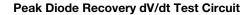
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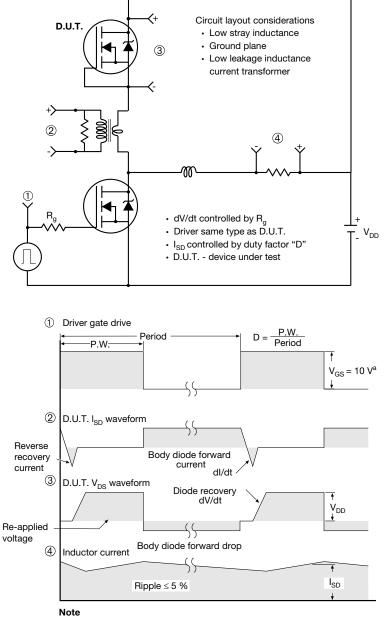
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a. $V_{GS} = 5 V$ for logic level devices

Fig. 19 - For N-Channel

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